OKI Semiconductor

DEMICONQUETOT Previous version: Mar. 1996

This version: Nov. 1997

MSM5839C

40-DOT SEGMENT DRIVER

GENERAL DESCRIPTION

The MSM5839C is a dot matrix LCD segment driver LSI which is fabricated using low power CMOS metal gate technology. This LSI consists of two 20-bit shift registers, two 20-bit latches, a 40-bit level shifter and a 40-bit 4-level driver.

It converts serial data, which is received from LCD controller LSI, into parallel data and outputs LCD driving waveform to the LCD panel.

Expansion of display can easily be made by increasing the number of characters and character patterns.

This LSI can drive a variety of LCD panels because the bias voltage, which determines an LCD driving voltage, can be optionally supplied from the external source.

FEATURES

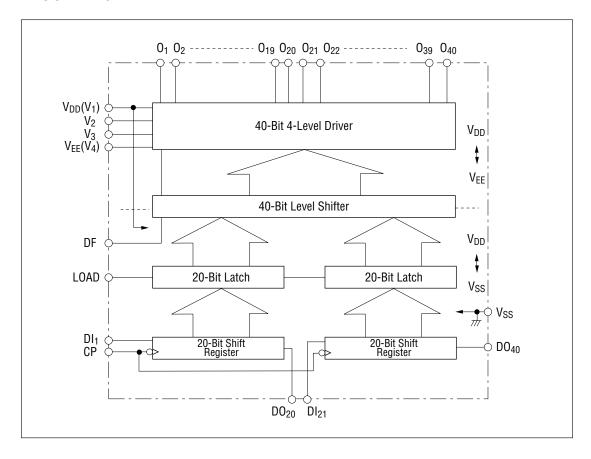
Supply voltage : 4.5 to 5.5V
LCD driving voltage : 4 to 11V
Applicable LCD duty : 1/3 to 1/64

• Bias voltage can be supplied externally.

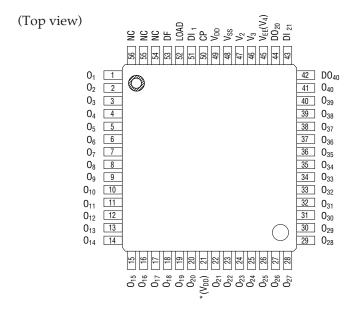
- Applicable commomn driver: MSM5238 (32 outputs)
- Package options:

56-pin plastic QFP (QFP56-P-910-0.65-K) (Product name: MSM5839C GS-K) 56-pin plastic QFP (QFP56-P-910-0.65-L2) (Product name: MSM5839C GS-L2)

BLOCK DIAGRAM

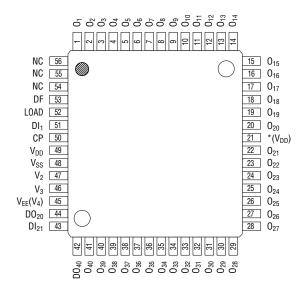


PIN CONFIGURATION (TOP VIEW)



NC: No connection

56-Pin Plastic QFP (Type K)



NC: No connection

56-Pin Plastic QFP (Type L)

Note: The figure for Type L shows the configuration viewed from the reverse side of the package. Pay attention to the difference in pin arrangement.

^{*} This pin is internally connected to V_{DD}, so connect it to the power supply or leave it open.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Supply Voltage (1)	V_{DD}	Ta = 25°C	-0.3 to +6	V
Supply Voltage (2)	V _{DD} – V _{EE} *1	Ta = 25°C	0 to 12	V
Input Voltage	V ₁	Ta = 25°C	-0.3 to V _{DD} +0.3	V
Storage Temperature	T _{STG}	_	−55 to +150	°C

 $V_{DD} > V_2 > V_3 > V_{EE}$ *1:

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Condition	Range	Unit
Supply Voltage (1)	V_{DD}	_	4.5 to 5.5	V
Supply Voltage (2)	V _{DD} – V _{EE} *1	_	4 to 11	V
Operating Temperature	T _{op}	_	-20 to +85	°C

^{*1:} $V_{DD}>V_{2}>V_{3}>V_{EE}$

ELECTRICAL CHARACTERISTICS

DC Characteristics

 $(V_{DD} = 5V \pm 10\%, Ta = -20 \text{ to } +85^{\circ}\text{C})$

	(*00	o o , o ,		,		
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
"H" Input Voltage	V _{IH} *1	_	0.8V _{DD}	_	V_{DD}	V
"L" Input Voltage	V _{IL} *1	_	V _{SS}	_	0.2V _{DD}	V
"H" Input Current	I _{IH} *1	$V_I = V_{DD}$	_		1	μА
"L" Input Current	I _{IL} *1	V _I = 0V	_	_	-1	μА
"H" output Voltage	V _{OH} *2	$I_0 = -0.4 \text{ mA}$	$V_{DD} - 0.4$	_	_	V
"L" output Voltage	V _{0L} *2	$I_0 = 0.4 \text{ mA}$	_	_	0.4	V
ON Resistance	R _{ON} *4	$V_{DD} - V_{EE} = 8V$ $ V_N - V_O = 0.25V$ *3	_	5	10	kΩ
Supply Current	I _{DD}	Connect all inputs to V_{DD} or V_{SS} $V_{DD} - V_{EE} = 11V$, No load	_	_	100	μА

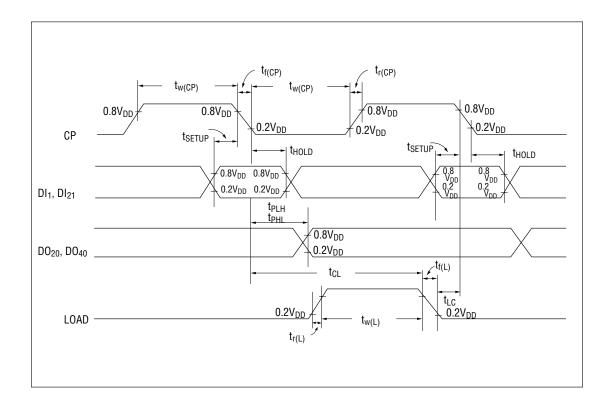
^{*1:} Applicable to LOAD, CP, DI₁, DI₂₁, DF

^{*2:} Applicable to DO_{20} , DO_{40} *3: $V_N = V_{DD}$ to V_{EE} , $V_2 = \frac{7}{9}$ ($V_{DD} - V_{EE}$), $V_3 = \frac{2}{9}$ ($V_{DD} - V_{EE}$) *4: Applicable to $O_1 - O_{40}$

Switching Characteristics

(Vnn :	$=5V \pm 10^{\circ}$	%. Ta =	-20° to	+85°C.	C_{i}	= 15 nF)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
"H", "L" Propagation Delay Time	t _{PLH} t _{PHL}	_	_	_	250	ns
Clock Frequency	f _{CP}	DUTY = 50%	_	_	2	MHz
Clock Pulse Width	t _{W(CP)}	_	150	_	_	ns
LOAD Pulse Width	t _{W(L)}	_	150	_	_	ns
Data Setup Time DI to CP	t _{SETUP}	_	100	_	_	ns
CP to LOAD Time	t _{CL}	_	250	_	_	ns
LOAD to CP Time	t _{LC}	_	0	_	_	ns
DATA Hold Time DI to CP	t _{HOLD}	_	50	_	_	ns
CP Rise/Fall Time	t _{r(CP)} t _{f(CP)}	_	_	_	50	ns
LOAD Rise/Fall Time	t _{r(L)}	_	_	_	1	μS



FUNCTIONAL DESCRIPTION

Pin Functional Description

• DI₁

The data input pin for the 20-bit shift register (from 1st to 20th bit). The display data is input to the data input pin in synchronization with a clock pulse.

• CP

Clock pulse input pin for the two 20-bit shift registers. The data is shifted in the two 20-bit shift registers at the falling edge of the clock pulse. Data setup time (t_{SETUP}) and data hold time (t_{HOLD}) are required between DI₁, DI₂₁ and CP.

DO₂₀

The 20th output bit of the shift register.

The data which is input from DI_1 is clocked out with a delay of the number of bits of the shift register (20). A 40-bit shift register can be configured by connecting the output of this pin to DI_{21} pin.

• DI₂₁

The data input pin for the 20-bit shift register (from 21st to 40th bit).

Connecting the DO_{20} pin and this pin allows the device to be used as a 40-bit shift register.

DO₄₀

The 40th output bit of the shift register.

The data which is input from DI_1 is clocked out with a delay of the number of the bits of the shift register.

When increasing the number of characters, this pin is used to cascade connect the next MSM5839C.

• DF

Alternate signal input pin for LCD driving waveform.

V_{DD}(V₁), V_{SS}

Supply voltage pins. V_{DD} should be 4.5 to 5.5V.

 V_{SS} is a ground pin ($V_{SS} = 0V$).

V₂, V₃, V_{EE}(V₄)

Bias supply voltage pins to drive the LCD. Bias voltage is supplied from an external source.

LOAD

The signal for latching the shift register contents is input from this pin.

When LOAD pin is set at "H", the shift register contents are transferred to the 40-bit 4-level driver. When LOAD pin is set at "L", the last display output data $(O_1 \text{ to } O_{40})$, which was transferred when LOAD pin was at "H", is held.

• O₁ to O₄₀

Display data output pins which correspond to each data bit in the latch.

One of V_{DD} , V_2 , V_3 or V_{EE} (V_4) is selected as a display driving voltage source based on the combination of latched data level and DF signal. Refer to the Truth Table below.

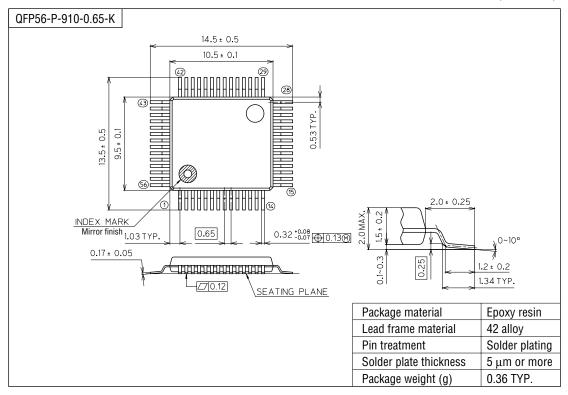
These pins should be connected to the SEGMENT side of the LCD panel.

Truth Table

Latched data	DF LCD driver output			
Н	Н	V _{EE} (V4)		
п	L	V _{DD} (V1)		
L	Н	V ₃		
	L	V ₂		

PACKAGE DIMENSIONS

(Unit: mm)

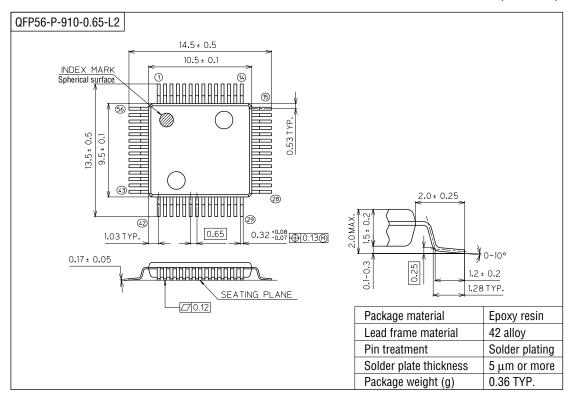


Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).